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IEEE STEE-2026

2026 IEEE 8TH INTERNATIONAL CONFERENCE

ON SMART TECHNOLOGIES IN POWER ENGINEERING AND **ELECTRONICS**

> **IEEE Kyiv Polytechnic Week** Igor Sikorsky Kyiv Polytechnic Institute April 27-30, 2026, Kyiv, Ukraine

CONFERENCE TOPICS

1. POWER AND INDUSTRIAL ELECTRONICS

DC-to-DC converters, AC-to-AC converters, Rectifiers, Inverters, Multilevel Converters; Drives, Energy Storages, Batteries, Chargers, Unconventional Power Electronics Converters; Power Electronics for Automotive Vehicles, Aircrafts, and Ships, Welding Machines; Converters' Control, Energy and Power System Control, Intelligent and Predictive Control in Power Electronics; Quality and Reliability in Power Systems, Electromagnetic Compatibility; Filters and Compensators, Active Power Quality Controllers.

2. ACOUSTICS, MULTIMEDIA AND SPEECH PROCESSING

Acoustic Engineering, Audio Engineering, Acoustic Systems, Processing of Acoustic Signals; Electroacoustic Devices and Systems, Acoustic Non-Destructive Testing, Acoustic Monitoring; Multimedia, Video and Image Processing, Image Transmission; Hydroacoustics, Ultrasonic Diagnostics, Medical Acoustics; Objective Hearing Diagnostic, Audiological Screening; Ultrasonic Transducers, Broadband Electroacoustic Transducers; Piezoelectricity; Acoustics Waves, Doppler Effect, Acoustic Sensors, Noise.

3. ELECTRONIC COMPONENTS, PACKAGING AND MANUFACTURING TECHNOLOGY

Modeling and Design in Electronics; Physical Testing, Thermal Management; Advanced Electronic Materials; Manufacturing, and Reliability of Electronics, Photonics, RF, MEMS, SAW-devises and Sensor Packaging; Integration to Ensure Electrical, Thermal, Thermo-mechanical, **Electromagnetic Performance and Security.**

INFORMATION FOR AUTHORS

Authors are invited to submit papers on English with size from 4 to 6 pages, prepared according to IEEE Conference template. Paper submission deadline is December 1, 2025. Authors of papers with positive reviews will be notified by email for final paper submission in PDF and DOC format. The submission Web page for IEEE STEE-2026 is https://cmt3.research.microsoft.com/STEE2026.

Accepted papers will be submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements. IEEE quality control of Conference Proceedings may lead to delays in posting the Proceedings in the IEEE Xplore Digital Library, or decline to post some papers that do not meet the IEEE quality criteria.

If you have any questions, please don't hesitate to contact organizing committee stee@ieee.org.ua.

INFORMATION FOR PARTICIPANTS FROM UKRAINE

For participants from Ukraine, if the number of foreign authors of the papers does not exceed 50%, discounts up to 96% for online and up to 91 % for onsite participation are provided. The following criteria will be considered:

- the quality of the paper based on the results of the Conference peer review;
- IEEE Ukraine Section Membership;
- volunteering in the IEEE Ukraine Section and its subunits and events;
- employee or student of Igor Sikorsky Kyiv Polytechnic Institute.

However, for papers with more than half foreign authors, payment of the registration fee in full size is MANDATORY.

IMPORTANTS DATES

PAPER SUBMISSION **DECEMBER 1, 2025**

REVIEW FEBRUARY 15, 2026

FINAL PAPER SUBMISSION MARCH 1, 2026

ACCEPTANCE NOTIFICATION MARCH 15, 2026

> **REGISTRATION APRIL 1, 2026**

CONFERENCE APRIL 27-30, 2026

PARTICIPATION FEE

IEEE MEMBER 240 EUR

IEEE STUDENT MEMBER 145 EUR

NON IEEE MEMBER 290 EUR

190 EUR STUDENT NON-IEEE MEMBER

